

350mA ADVANCED CURRENT REGULATOR

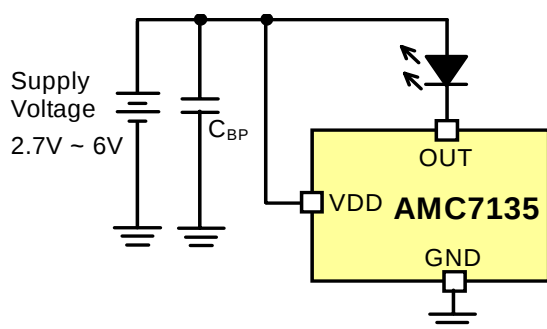
DESCRIPTION

The AMC7135 is a low dropout current regulator rated for 350mA constant sink current. The low quiescent current and low dropout voltage is achieved by advanced Bi-CMOS process.

FEATURES

- 350mA constant sink current.
- Output short / open circuit protection.
- Low dropout voltage.
- Low quiescent current
- Supply voltage range 2.7V ~ 6V
- 2KV HBM ESD protection
- Advanced Bi-CMOS process.
- SOT-89 and TO-252 package

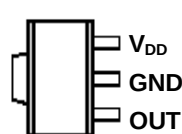
TYPICAL APPLICATION CIRCUIT



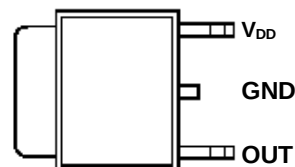
APPLICATIONS

- Power LED driver

PACKAGE PIN OUT



SOT-89



TO-252

(Top View)

ORDER INFORMATION

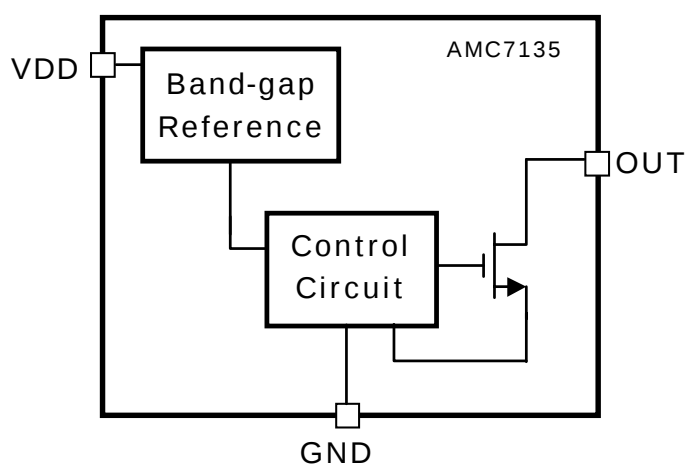
I _{OUT}	PK	SOT-89	SJ	TO-252
		3-pin		3-pin
340-380mA		AMC7135PKF		AMC7135SJF
300-340mA		AMC7135PKFA		AMC7135SJFA

Note: 1. All surface-mount packages are available in Tape & Reel. Append the letter "T" to part number (i.e. AMC7135PKFAT).
2. The letter "F" is marked for Lead Free process.
3. The letter "A" is marked for current ranking.

ABSOLUTE MAXIMUM RATINGS (Note)

Input Voltage, V_{DD}	-0.3V to 7V
Output Voltage, V_{OUT}	-0.3V to 7V
Maximum Junction Temperature, T_J	150°C
Storage Temperature Range	-40°C to 150°C
Lead Temperature (Soldering, 10 seconds)	260°C

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground.
Currents are positive into, negative out of the specified terminal.

BLOCK DIAGRAM

PIN DESCRIPTION

Pin Name	Pin Function
V_{DD}	Power supply.
OUT	Output pins. Connected to load.
GND	Ground.

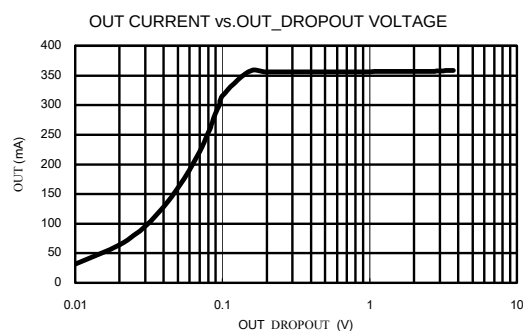
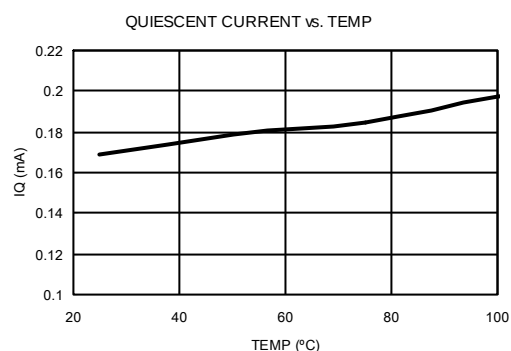
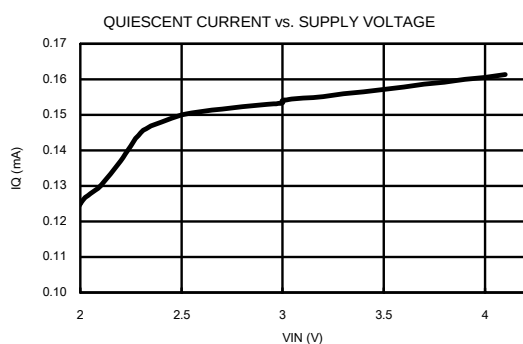
RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage	V_{DD}	2.7		6	V
Output Sink Current	I_{OUT}			400	mA
Operating Free-air Temperature Range	T_A	-40		+85	°C

DC ELECTRICAL CHARACTERISTICS
 $V_{DD}=3.7V$, $T_A=25^{\circ}C$, No Load, (Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Apply Pin
Output Sink Current	I_{SINK}	$V_{OUT}=0.2V$	340	360	380	mA	OUT
		$V_{OUT}=0.2V$, Rank A	300	320	340	mA	
Load Regulation		$V_{OUT}=0.2V$ to 3V			3	mA/V	
Line Regulation		$V_{DD}=3V$ to 6V, $V_{OUT}=0.2V$			3	mA/V	
Output Dropout Voltage	V_{OUTL}			120		mV	
Supply Current Consumption	I_{DD}			200		uA	VDD

Note 1: Output dropout voltage: $90\% \times I_{OUT}$ @ $V_{OUT}=200mV$

TYPICAL OPERATION CHARACTERISTICS


APPLICATION INFORMATION

The Maximum Power Dissipation on Regulator:

$$P_{D(MAX)} = V_{OUT(MAX)} \times I_{OUT(NOM)} + V_{IN(MAX)} \times I_Q$$

$V_{OUT(MAX)}$ = the maximum voltage on output pin;

$I_{OUT(NOM)}$ = the nominal output current;

I_Q = the quiescent current the regulator consumes at $I_{OUT(MAX)}$;

$V_{IN(MAX)}$ = the maximum input voltage.

Thermal Consideration:

The maximum junction temperature ratings of AMC7135 should not be exceeded under continuous normal load conditions. When power consumption is over about 700mW (SOT-89 package, at $T_A=70^\circ\text{C}$) or 1000mW (TO-252 package, at $T_A=70^\circ\text{C}$), additional heat sink is required to control the junction temperature below 120°C .

The junction temperature is:

$$T_J = P_D (\theta_{JT} + \theta_{CS} + \theta_{SA}) + T_A$$

P_D : Dissipated power.

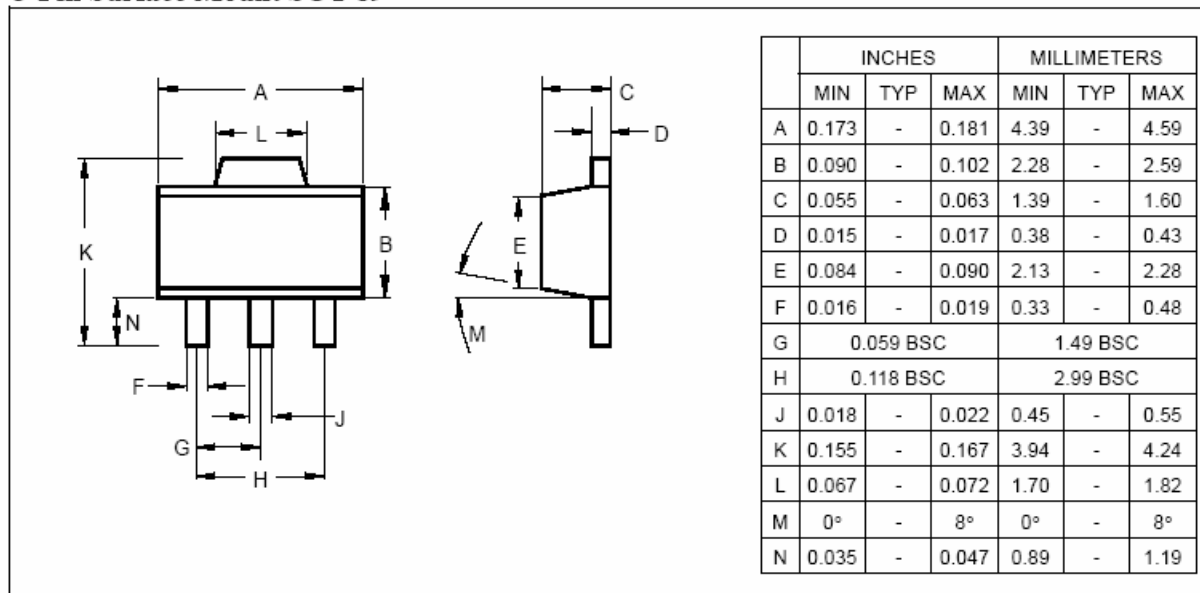
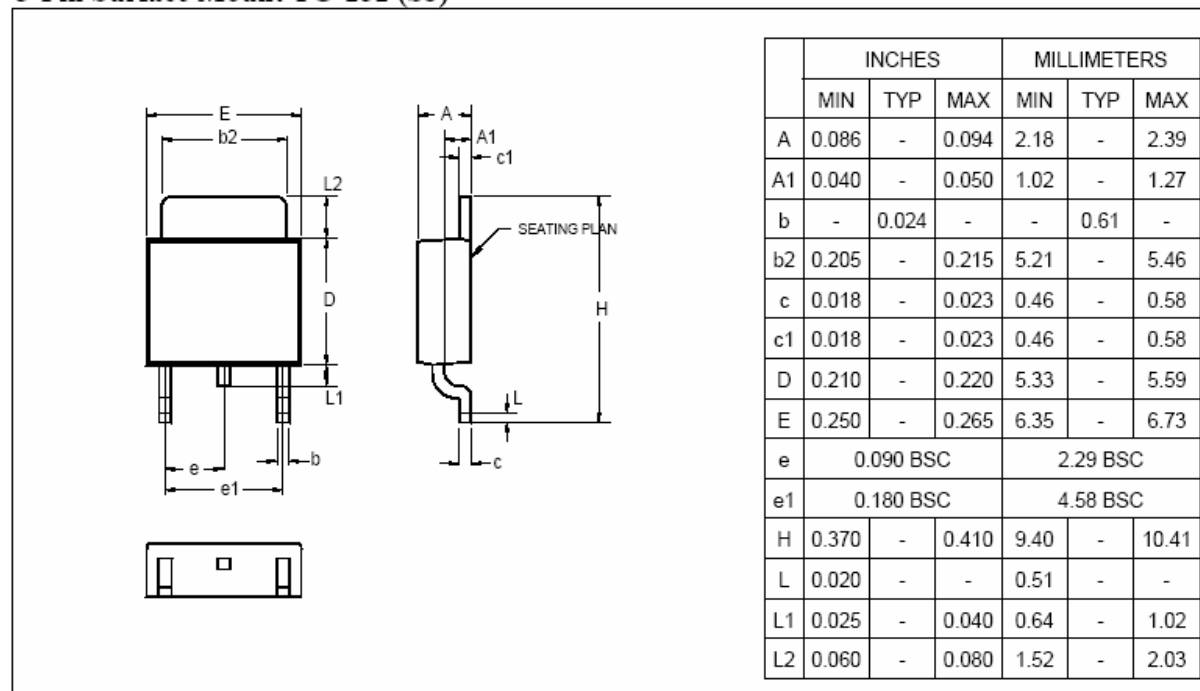
θ_{JT} : Thermal resistance from the junction to the mounting tab of the package.

θ_{CS} : Thermal resistance through the interface between the IC and the surface on which it is mounted.
(typically, $\theta_{CS} < 1.0^\circ\text{C/W}$)

θ_{SA} : Thermal resistance from the mounting surface to ambient (thermal resistance of the heat sink).

If PC Board copper is going to be used as a heat sink, below table can be used to determine the appropriate size of copper foil required. For multi-layered PCB, these layers can also be used as a heat sink. They can be connected with several through-hole vias.

PCB θ_{SA} ($^\circ\text{C/W}$)	59	45	38	33	27	24	21
PCB heat sink size (mm^2)	500	1000	1500	2000	3000	4000	5000

PACKAGE
3-Pin Surface Mount SOT-89

3-Pin Surface Mount TO-252 (SJ)


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